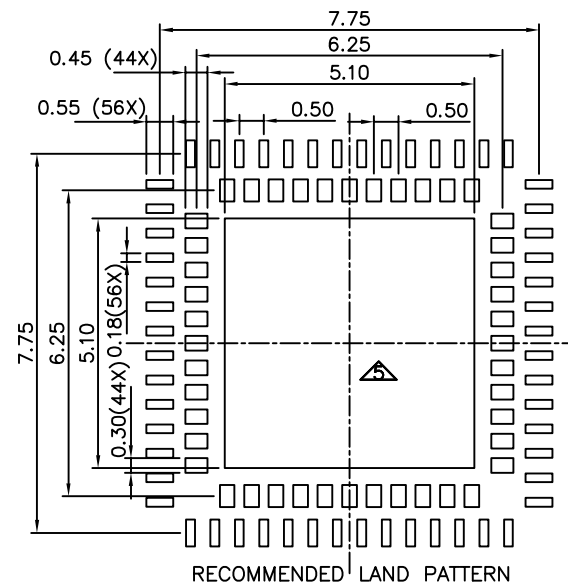
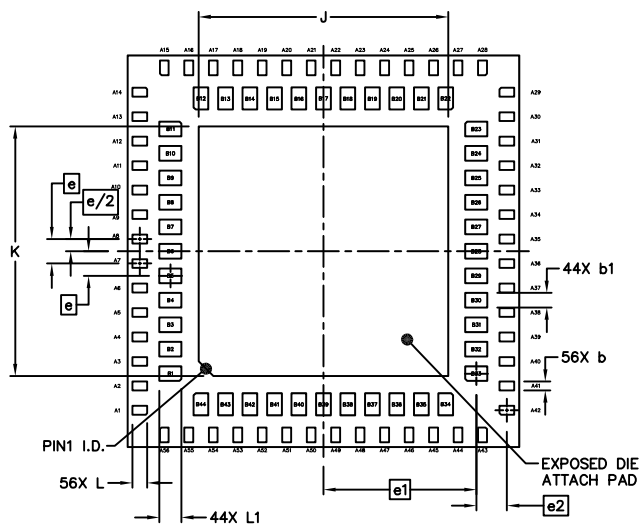


	SYMBOL	MIN	NOM	MAX
TOTAL THICKNESS	A	0.50	0.55	0.60
STAND OFF	A1	0.02	0.05	0.08
MOLD THICKNESS		0.43		REF
L/F THICKNESS		0.125		REF
LEAD WIDTH				
	b	0.13	0.18	0.23
	b1	0.25	0.3	0.35
BODY SIZE	X	D	8.0	BSC
	Y	E	8.0	BSC
LEAD PITCH	e	0.5		BSC
	e1	3.125		BSC
	e2	0.625		BSC
EP SIZE	X	J	5.0	5.1
	Y	K	5.0	5.1
LEAD LENGTH	L	0.25	0.3	0.35
	L1	0.40	0.45	0.50
PACKAGE EDGE TOLERANCE	aaa		0.10	
MOLD FLATNESS	ccc		0.08	
COPLANARITY	eee		0.08	



#### NOTE :

1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY APPLIES TO THE EXPOSED THERMAL PAD AS WELL AS THE TERMINALS.
3. REFER JEDEC MO-288
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.
5. THERMAL PAD SOLDERING AREA (MESH STENCIL DESIGN IS RECOMMENDED).



DESCRIPTION: U-QFN8080-100

PACKAGE CODE: ZXD (ZXD100)

DOCUMENT CONTROL #: PD-2270

DATE: 07/22/21

REVISION: --